
CMOS 3ch-LDOs for RF Unit

NO. EA-099-0606

OUTLINE

The R5324D Series are CMOS-based multi positive voltage regulator ICs with high output voltage accuracy, low supply current, low noise, low dropout and high ripple rejection. The R5324D Series contain three voltage regulators. Each of these voltage regulators in the R5324D Series consists of a voltage reference unit, an error amplifier, resistors for setting output voltage, a short current limit circuit, a chip enable circuit, and so on.

The chip enable function contributes to prolong battery life. Further, regulators in the R5324D Series are with low dropout voltage, excellent load transient response and line transient response, thus the R5324D series are very suitable for the power supply for hand-held communication equipment.

Since the package for these ICs is SON-8, high density mounting of the ICs on boards is possible.

FEATURES

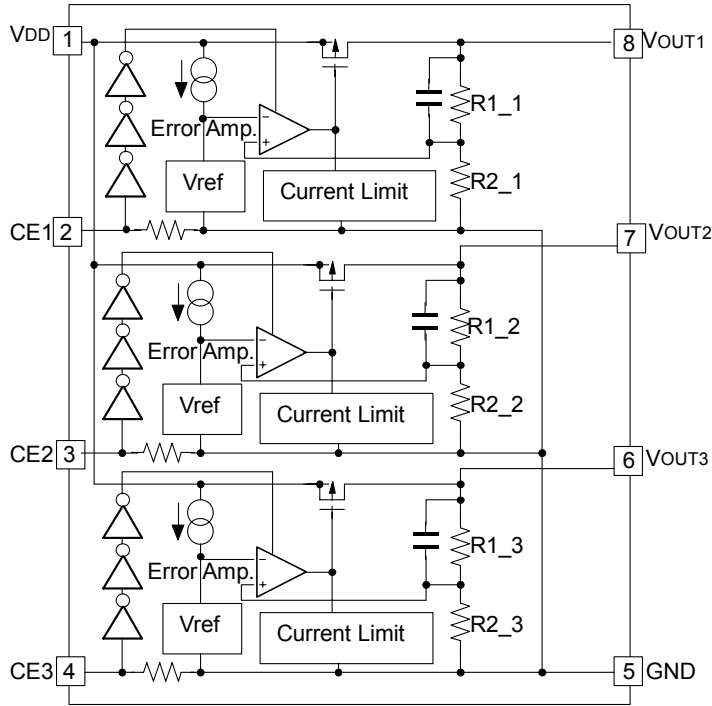
- Low Supply Current Typ. 90 μ A (VR1, VR2, VR3)
- Low Standby Current Typ. 0.1 μ A
- Low Dropout Voltage..... Typ. 0.23V (VR1) ($I_{OUT}=200mA, V_{OUT}=3.0V$)
Typ. 0.22V (VR2) ($I_{OUT}=150mA, V_{OUT}=3.0V$)
Typ. 0.15V (VR3) ($I_{OUT}=100mA, V_{OUT}=3.0V$)
- High Ripple Rejection Typ. 70dB (f=1kHz), Typ. 65dB (f=10kHz),
- High Output Voltage Accuracy $\pm 2.0\%$
- Low Temperature-Drift Coefficient of Output Voltage..... Typ. $\pm 100ppm/^{\circ}C$
- Excellent Line Regulation Typ. 0.02%/V
- Excellent Load Transient Response and Line Transient Response
- Small Package SON-8
- Built-in fold-back protection circuit Typ. 50mA (VR1), Typ. 40mA (VR2, VR3)
- Ceramic Capacitor Recommended for Output 1.0 μ F or more

APPLICATIONS

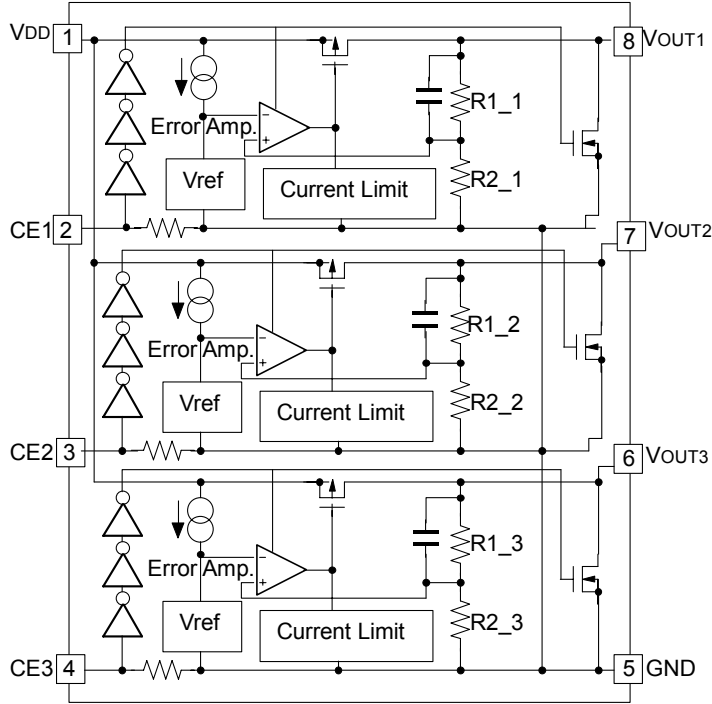
- Power source for cellular phones and portable communication equipment.
- Power source for electrical appliances such as cameras, VCRs.
- Power source for battery-powered equipment.

BLOCK DIAGRAMS

R5324DxxxA



R5324DxxxB



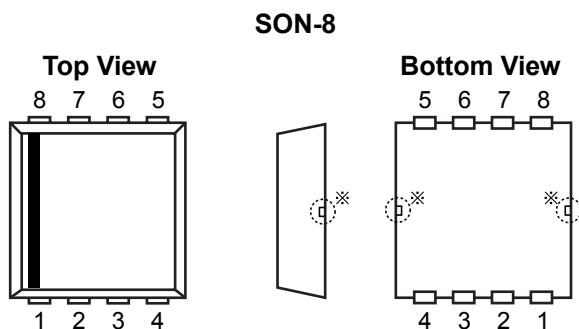
SELECTION GUIDE

The selection can be made with designating the part number as shown below:

R5324Dxxxx-xx-X ←Part Number
 ↑ ↑ ↑ ↑
 a b c d


Code	Contents
a	Serial Number for Voltage setting from 001
b	Alphabetical Code for Mask Versions A: Standard B: With auto discharge function at off state
c	Designation of Taping Type (TR is described as standard.)
d	Designation of Composition of pin plating. -F : Lead free plating

PIN CONFIGURATIONS



PIN DESCRIPTIONS

Pin No	Symbol	Pin Description
1	V _{DD}	Input Pin
2	CE1	Chip Enable Pin 1
3	CE2	Chip Enable Pin 2
4	CE3	Chip Enable Pin 3
5	GND	Ground Pin
6	V _{OUT3}	Output Pin 3
7	V _{OUT2}	Output Pin 2
8	V _{OUT1}	Output Pin 1

* Tab in the  parts have GND level. (They are connected to the reverse side of this IC.)
Do not connect to other wires or land patterns.

ABSOLUTE MAXIMUM RATINGS

Symbol	Item	Rating	Unit
V _{IN}	Input Voltage	6.5	V
CE	Input Voltage (CE Pin)	-0.3~V _{IN} +0.3	V
V _{OUT}	Output Voltage	-0.3~V _{IN} +0.3	V
I _{OUT1}	Output Current (V _{OUT1})	230	mA
I _{OUT2}	Output Current (V _{OUT2})	180	mA
I _{OUT3}	Output Current (V _{OUT3})	180	mA
P _d	Power Dissipation (SON-8)*	480	mW
T _{opt}	Operating Temperature Range	-40~85	°C
T _{stg}	Storage Temperature Range	-55~125	°C

*) For Power Dissipation, please refer to PACKAGE INFORMATION to be described.

ELECTRICAL CHARACTERISTICS

• R5324DxxxA/B

VR1

T_{opt}=25°C

Symbol	Item	Conditions	Min.	Typ.	Max.	Unit
V _{OUT}	Output Voltage	V _{IN} -V _{OUT} =1.0V 1mA ≤ I _{OUT} ≤ 30mA	×0.980		×1.020	V
I _{OUT}	Output Current	V _{IN} -V _{OUT} =1.0V	200			mA
ΔV _{OUT} /ΔI _{OUT}	Load Regulation	V _{IN} -V _{OUT} =1.0V 1mA ≤ I _{OUT} ≤ 200mA		25	50	mV
V _{DIF}	Dropout Voltage	Refer to Electrical Characteristic by Output Voltage (VR1)				
I _{SS}	Supply Current	V _{IN} -V _{OUT} =1.0V		90	140	μA
I _{standby}	Supply Current (Standby)	V _{IN} -V _{OUT} =1.0V, V _{CE} =GND		0.1	1.0	μA
ΔV _{OUT} /ΔV _{IN}	Line Regulation	V _{OUT} +0.5V ≤ V _{IN} ≤ 6.0V I _{OUT} =30mA (V _{OUT} ≥ 2.0V: 2.2V ≤ V _{IN} ≤ 6.0V)		0.02	0.10	%/V
RR	Ripple Rejection	f=1kHz f=10kHz f=10kHz (V _{OUT} ≥ 2.5V) sinusoidal Ripple 0.5Vp-p V _{IN} -V _{OUT} =1.0V, I _{OUT} =30mA V _{OUT} ≤ 1.7V, V _{IN} -V _{OUT} =1.2V		70 65 60		dB
V _{IN}	Input Voltage		2.0		6.0	V
ΔV _{OUT} /ΔT _{opt}	Output Voltage Temperature Coefficient	I _{OUT} =30mA -40°C ≤ T _{opt} ≤ 85°C		±100		ppm/°C
I _{lim}	Short Current Limit	V _{OUT} =0V		40		mA
R _{PD}	CE Pull-down Resistance		0.7	2.0	5.0	MΩ
V _{CEH}	CE Input Voltage "H"		1.5		6.0	V
V _{CEL}	CE Input Voltage "L"		0.0		0.3	V
en	Output Noise	BW=10Hz~100kHz		30		μVrms
R _{LOW}	On Resistance of Nch Tr. for Auto-discharge (Applied to B version)	V _{CE} =0V		50		Ω

• ELECTRICAL CHARACTERISTICS by OUTPUT VOLTAGE (VR1)

T_{opt} = 25°C

Output Voltage V _{OUT} (V)	Dropout Voltage V _{DIF} (V)		
	Condition	Typ.	Max.
V _{OUT} =1.5	I _{OUT} =200mA	0.36	0.65
V _{OUT} =1.6		0.34	0.58
V _{OUT} =1.7		0.33	0.56
1.8 ≤ V _{OUT} ≤ 2.0		0.31	0.53
2.1 ≤ V _{OUT} ≤ 2.7		0.28	0.46
2.8 ≤ V _{OUT} ≤ 4.0		0.23	0.35

R5324D

VR2

T_{opt}=25°C

Symbol	Item	Conditions	Min.	Typ.	Max.	Unit
V _{OUT}	Output Voltage	V _{IN} -V _{OUT} =1.0V 1mA ≤ I _{OUT} ≤ 30mA	×0.980		×1.020	V
I _{OUT}	Output Current	V _{IN} -V _{OUT} =1.0V	150			mA
ΔV _{OUT} /ΔI _{OUT}	Load Regulation	V _{IN} -V _{OUT} =1.0V 1mA ≤ I _{OUT} ≤ 150mA		15	40	mV
V _{DIF}	Dropout Voltage	Refer to Electrical Characteristic by Output Voltage (VR2)				
I _{SS}	Supply Current	V _{IN} -V _{OUT} =1.0V		90	120	μA
I _{standby}	Supply Current (Standby)	V _{IN} -V _{OUT} =1.0V, V _{CE} =GND		0.1	1.0	μA
ΔV _{OUT} /ΔV _{IN}	Line Regulation	V _{OUT} +0.5V ≤ V _{IN} ≤ 6.0V I _{OUT} =30mA (V _{OUT} ≤ 1.6V: 2.2V ≤ V _{IN} ≤ 6.0V)		0.02	0.10	%/V
RR	Ripple Rejection	f=1kHz f=10kHz f=10kHz (V _{OUT} ≥ 2.5V) sinusoidal Ripple 0.5Vp-p V _{IN} -V _{OUT} =1.0V, I _{OUT} =30mA V _{OUT} ≤ 1.7V, V _{IN} -V _{OUT} =1.2V		70 65 60		dB
V _{IN}	Input Voltage		2.0		6.0	V
ΔV _{OUT} /ΔT _{opt}	Output Voltage Temperature Coefficient	I _{OUT} =30mA -40°C ≤ T _{opt} ≤ 85°C		±100		ppm/°C
I _{lim}	Short Current Limit	V _{OUT} =0V		40		mA
R _{PD}	CE Pull-down Resistance		0.7	2.0	5.0	MΩ
V _{CEH}	CE Input Voltage "H"		1.5		6.0	V
V _{CEL}	CE Input Voltage "L"		0.0		0.3	V
en	Output Noise	BW=10Hz~100kHz		30		μVrms
R _{LOW}	On Resistance of Nch Tr. for Auto-discharge (Applied to B version)	V _{CE} =0V		50		Ω

• ELECTRICAL CHARACTERISTICS by OUTPUT VOLTAGE (VR2)

T_{opt} = 25°C

Output Voltage V _{OUT} (V)	Dropout Voltage V _{DIF} (V)		
	Condition	Typ.	Max.
V _{OUT} =1.5	I _{OUT} =150mA	0.34	0.60
V _{OUT} =1.6		0.32	0.56
V _{OUT} =1.7		0.31	0.53
1.8 ≤ V _{OUT} ≤ 2.0		0.29	0.50
2.1 ≤ V _{OUT} ≤ 2.7		0.26	0.44
2.8 ≤ V _{OUT} ≤ 4.0		0.22	0.33

VR3

T_{opt}=25°C

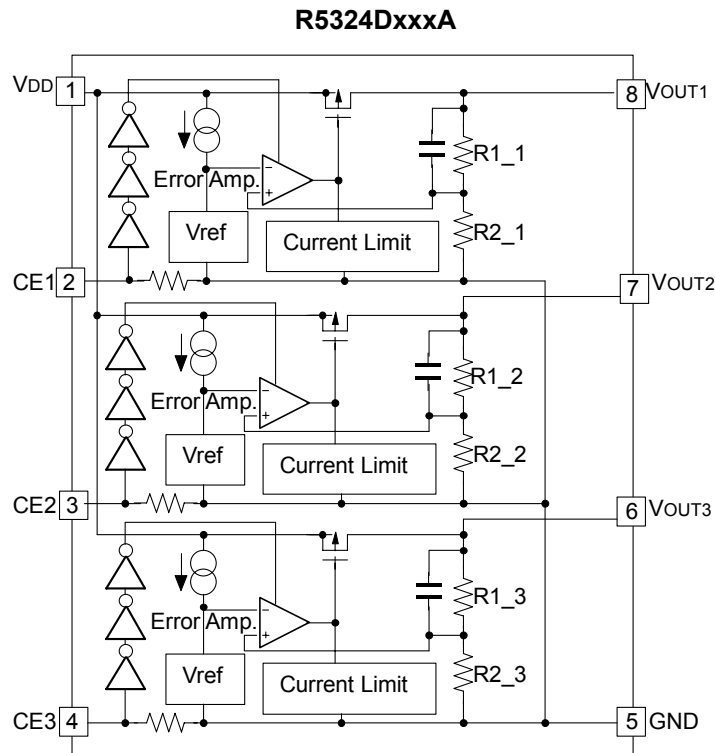
Symbol	Item	Conditions	Min.	Typ.	Max.	Unit
V _{OUT}	Output Voltage	V _{IN} -V _{OUT} =1.0V 1mA ≤ I _{OUT} ≤ 30mA	×0.980		×1.020	V
I _{OUT}	Output Current	V _{IN} -V _{OUT} =1.0V	100			mA
ΔV _{OUT} /ΔI _{OUT}	Load Regulation	V _{IN} -V _{OUT} =1.0V 1mA ≤ I _{OUT} ≤ 100mA		8	20	mV
V _{DIF}	Dropout Voltage	Refer to Electrical Characteristic by Output Voltage (VR3)				
I _{SS}	Supply Current	V _{IN} -V _{OUT} =1.0V		90	120	μA
I _{standby}	Supply Current (Standby)	V _{IN} -V _{OUT} =1.0V, V _{CE} =GND		0.1	1.0	μA
ΔV _{OUT} /ΔV _{IN}	Line Regulation	V _{OUT} +0.5V ≤ V _{IN} ≤ 6.0V I _{OUT} =30mA		0.02	0.10	%/V
RR	Ripple Rejection	f=1kHz f=10kHz f=10kHz (V _{OUT} ≥ 2.5V) sinusoidal Ripple 0.5Vp-p V _{IN} -V _{OUT} =1.0V, I _{OUT} =30mA V _{OUT} ≤ 1.7V, V _{IN} -V _{OUT} =1.2V		70 65 60		dB
V _{IN}	Input Voltage		2.0		6.0	V
ΔV _{OUT} /ΔT _{opt}	Output Voltage Temperature Coefficient	I _{OUT} =30mA -40°C ≤ T _{opt} ≤ 85°C		±100		ppm/°C
I _{lim}	Short Current Limit	V _{OUT} =0V		40		mA
R _{PD}	CE Pull-down Resistance		0.7	2.0	5.0	MΩ
V _{CEH}	CE Input Voltage "H"		1.5		6.0	V
V _{CEL}	CE Input Voltage "L"		0.0		0.3	V
en	Output Noise	BW=10Hz~100kHz		30		μVrms
R _{LOW}	On Resistance of Nch Tr. for Auto-discharge (Applied to B version)	V _{CE} =0V		50		Ω

• ELECTRICAL CHARACTERISTICS by OUTPUT VOLTAGE (VR3)

T_{opt} = 25°C

Output Voltage V _{OUT} (V)	Dropout Voltage V _{DIF} (V)		
	Condition	Typ.	Max.
V _{OUT} =1.5	I _{OUT} =100mA	0.24	0.44
V _{OUT} =1.6		0.22	0.40
V _{OUT} =1.7		0.21	0.38
1.8 ≤ V _{OUT} ≤ 2.0		0.20	0.37
2.1 ≤ V _{OUT} ≤ 2.7		0.18	0.33
2.8 ≤ V _{OUT} ≤ 4.0		0.15	0.25

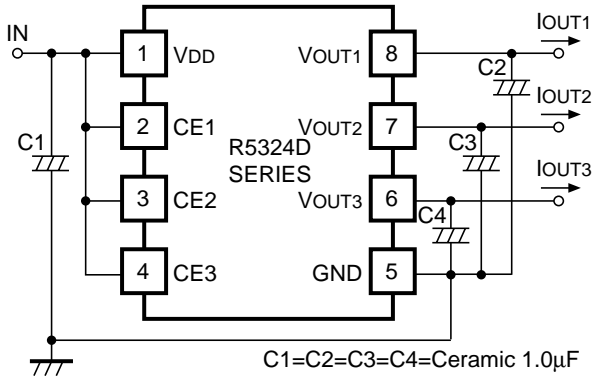
OPERATION



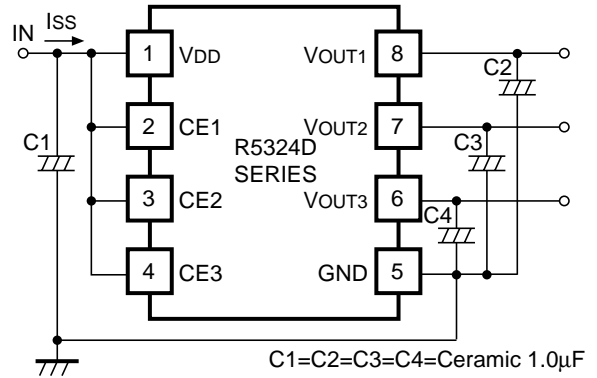
Fluctuation of each regulator's output voltage, or V_{OUT1} , V_{OUT2} , V_{OUT3} is detected individually. Then it is put back to an error amplifier through feedback resistors, or $R1_1$, $R2_1$, $R1_2$, $R2_2$, $R1_3$, $R2_3$ and compared with a reference voltage and compensated for the result and make a constant voltage.

In each regulator, short protection is made with a current limit circuit and stand-by mode is available by a chip enable circuit.

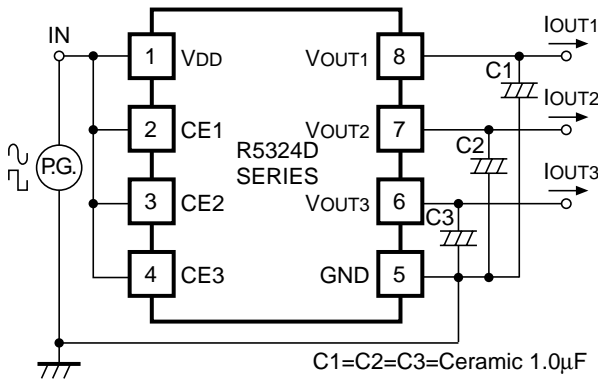
TEST CIRCUIT



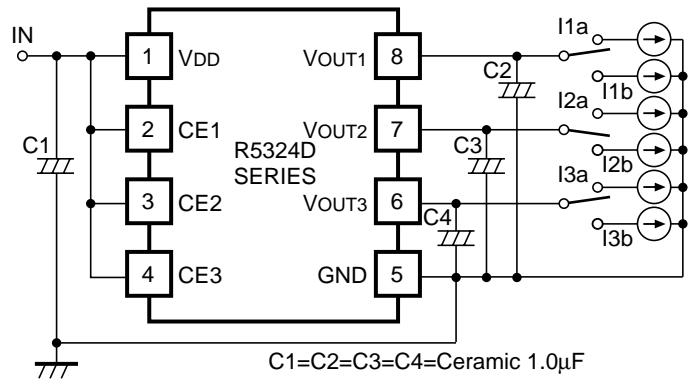
Standard Test Circuit



Supply Current Test Circuit



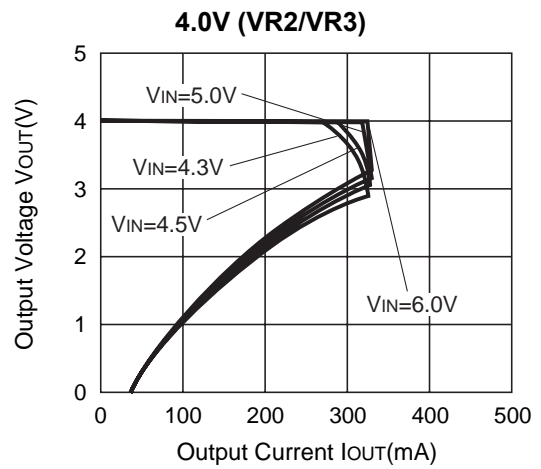
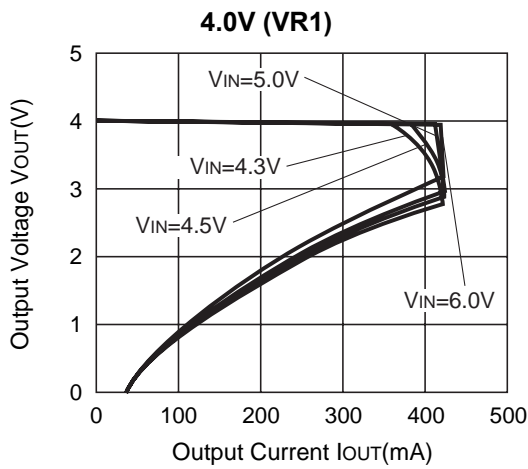
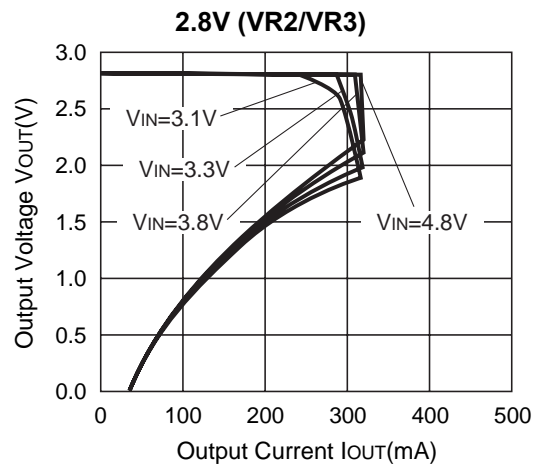
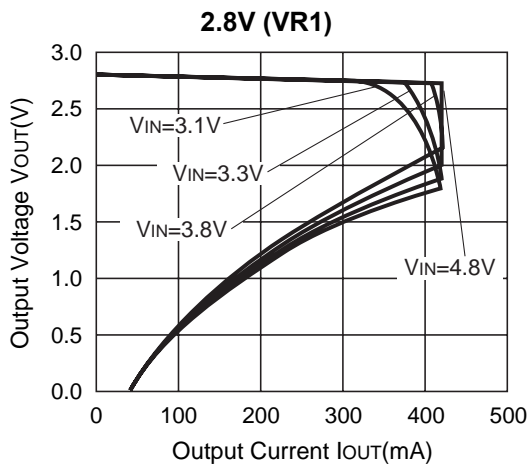
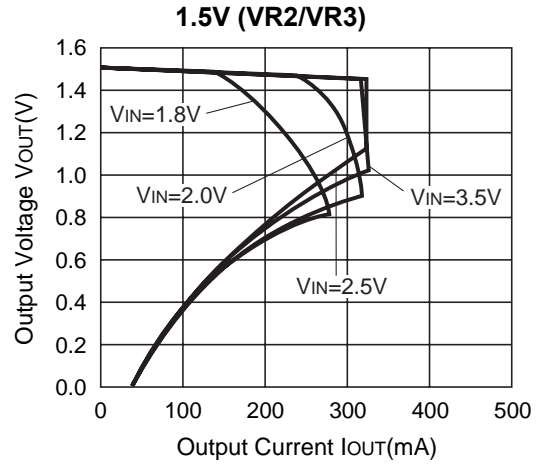
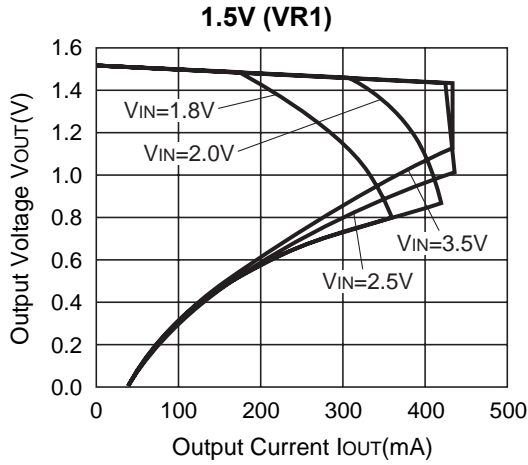
Ripple Rejection, Input Transient Response Test Circuit



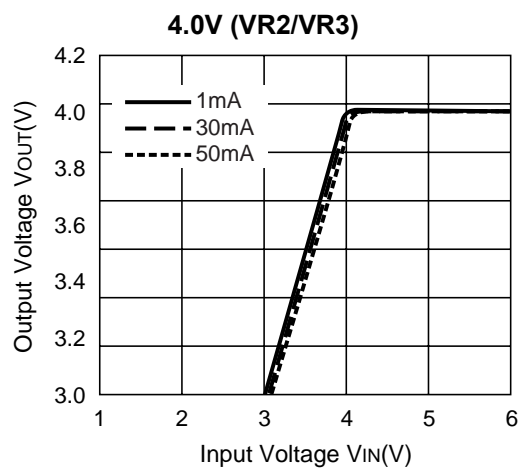
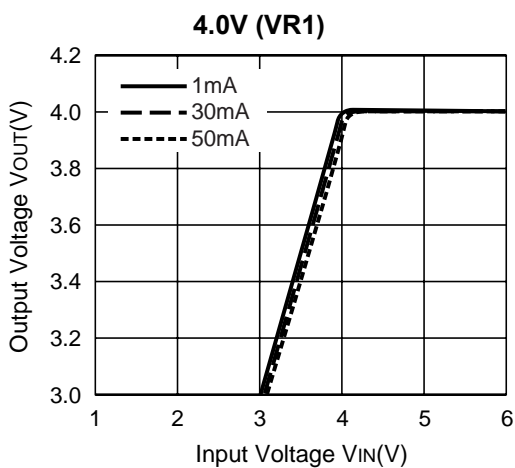
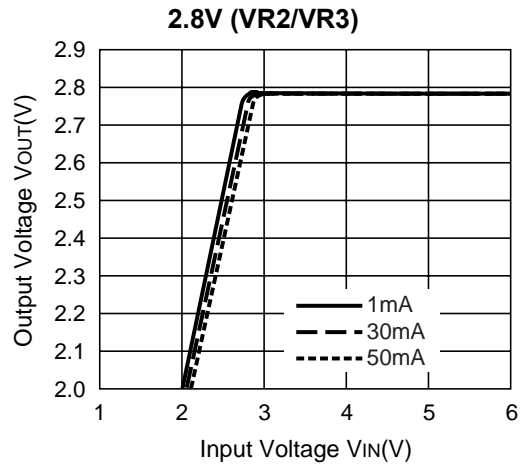
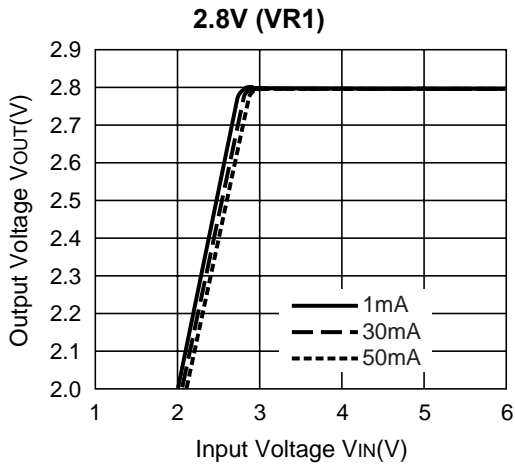
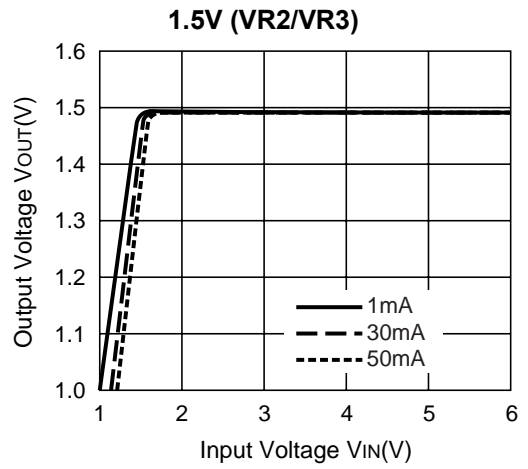
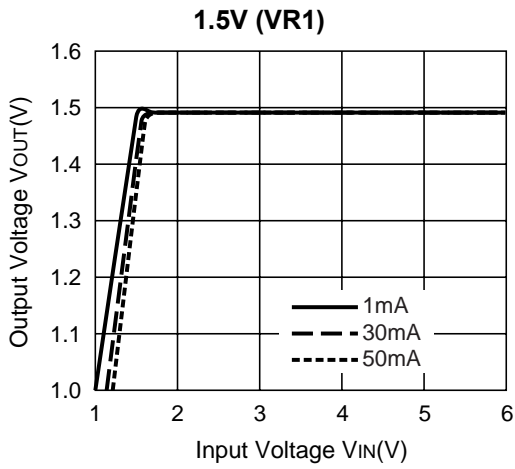
Load Transient Response Test Circuit

TYPICAL CHARACTERISTICS

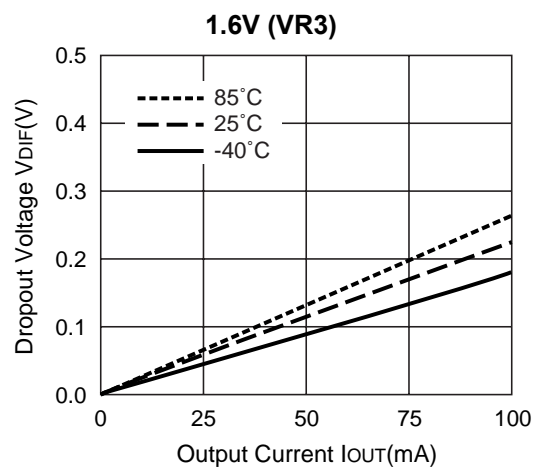
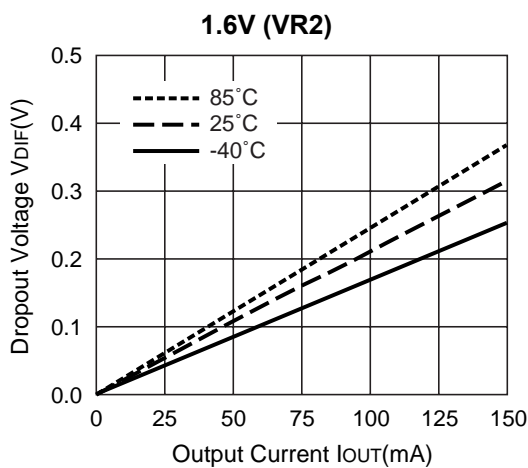
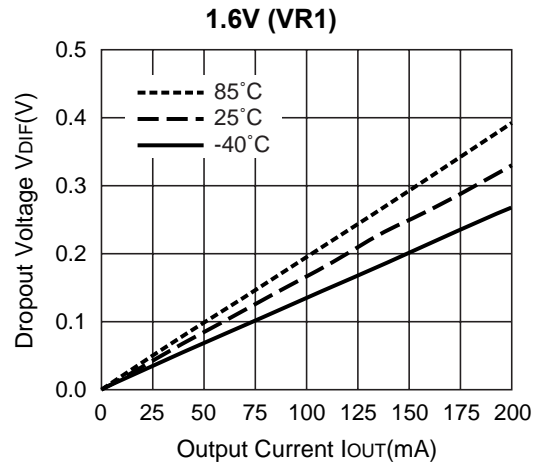
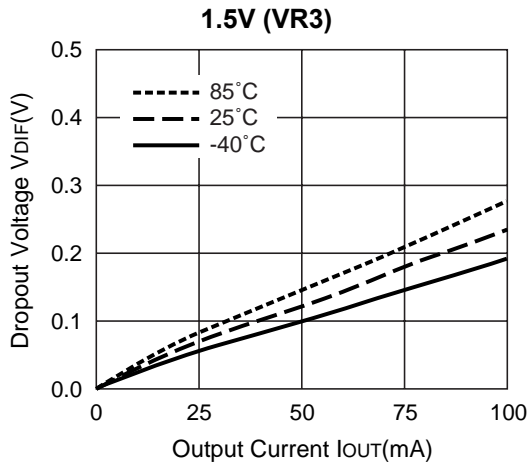
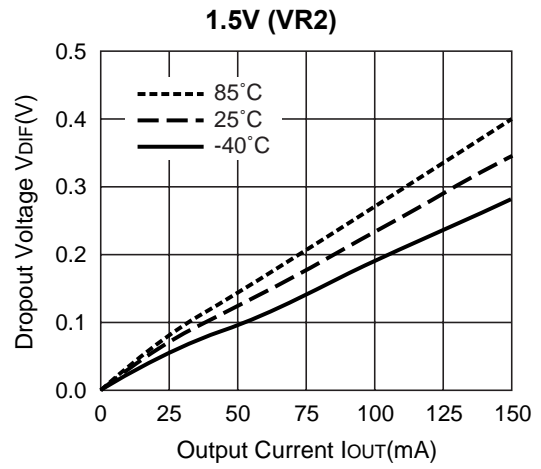
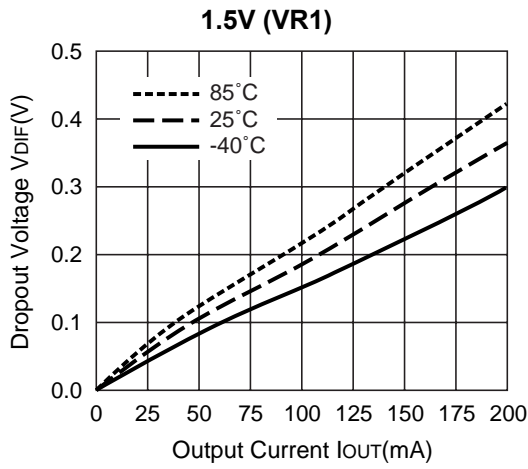
1) Output Voltage vs. Output Current (Topt=25°C)

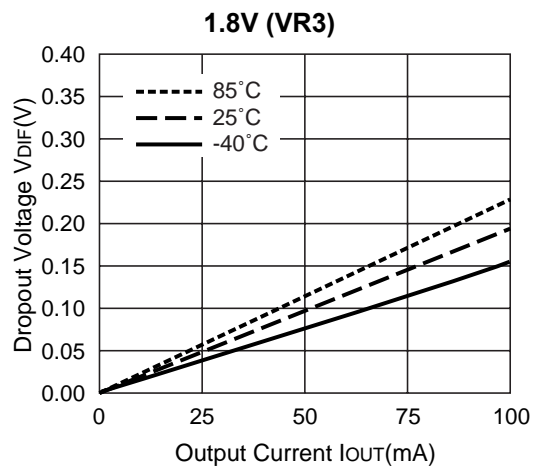
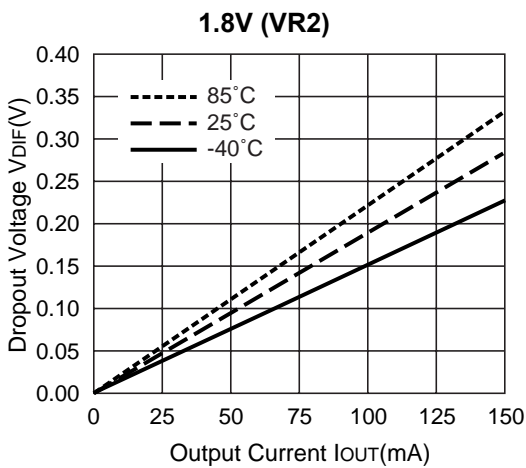
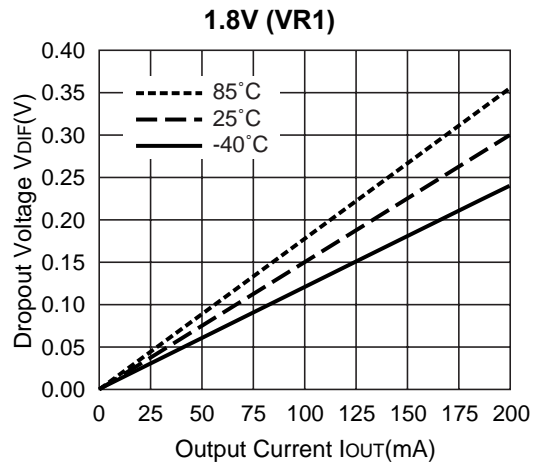
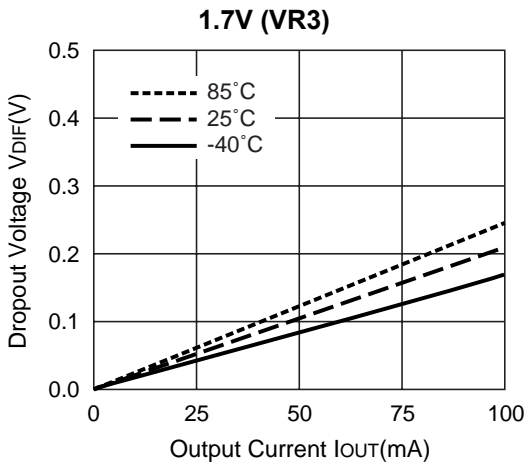
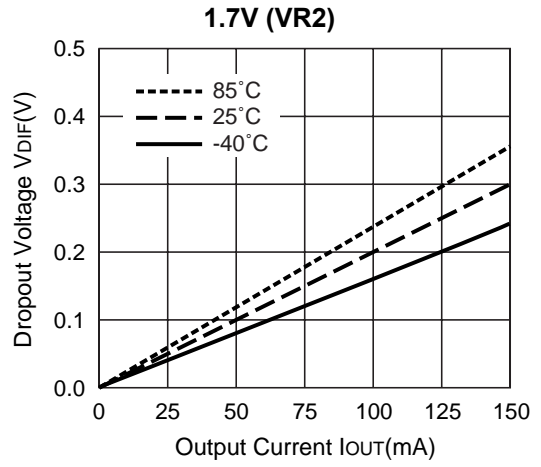
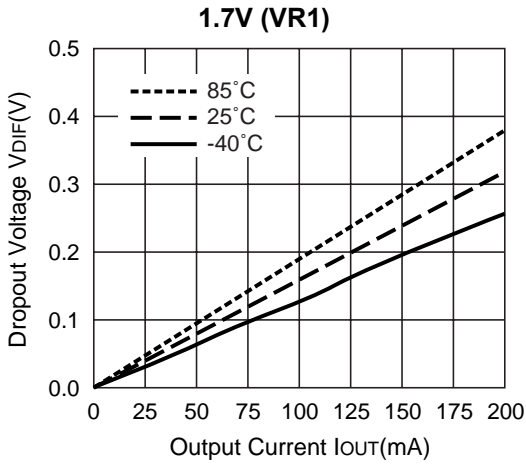


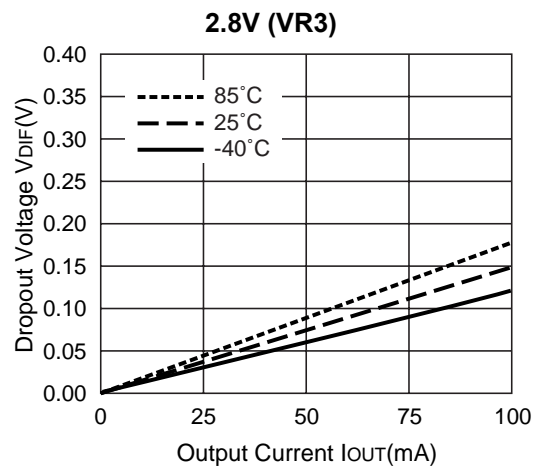
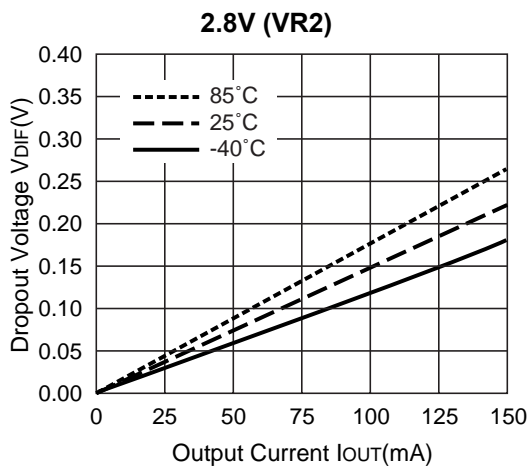
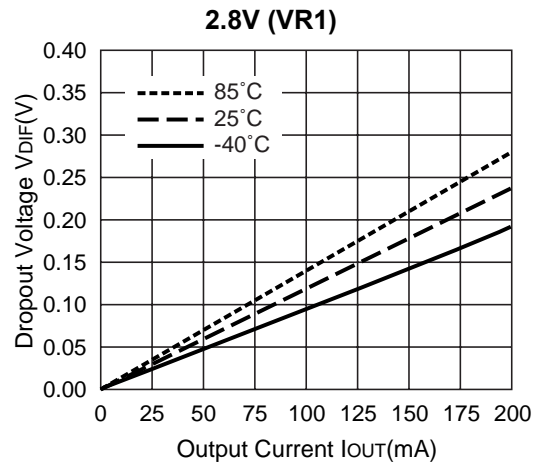
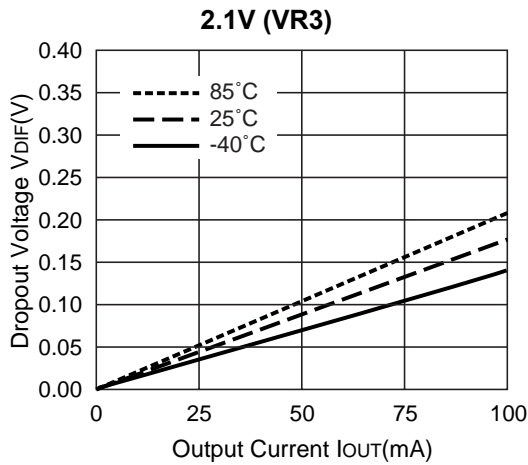
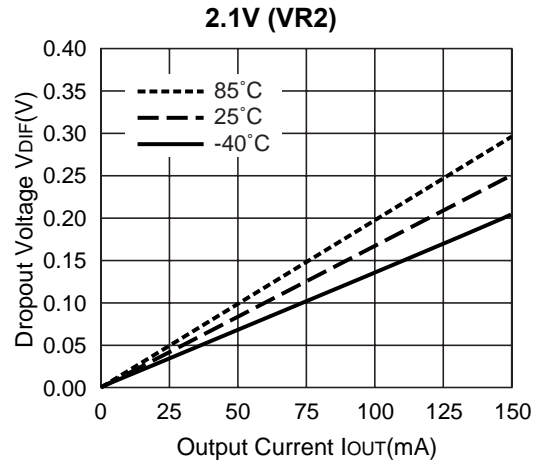
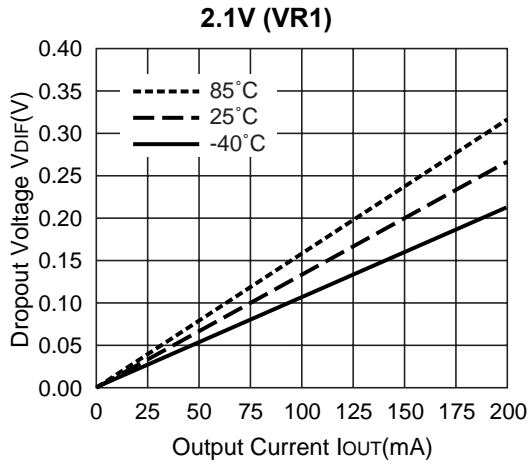
2) Output Voltage vs. Input Voltage (T_{opt}=25°C)

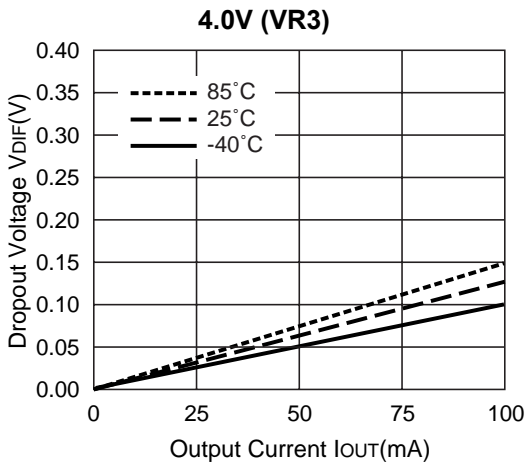
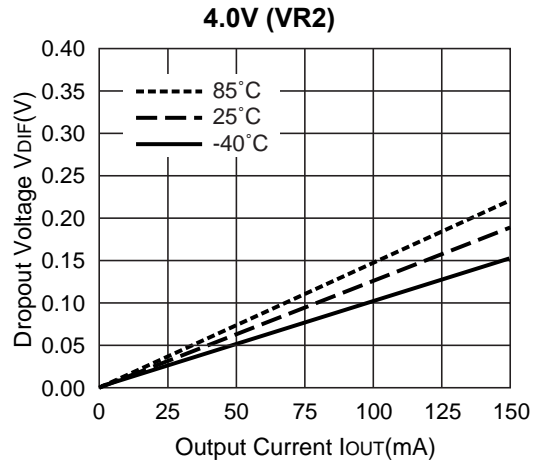
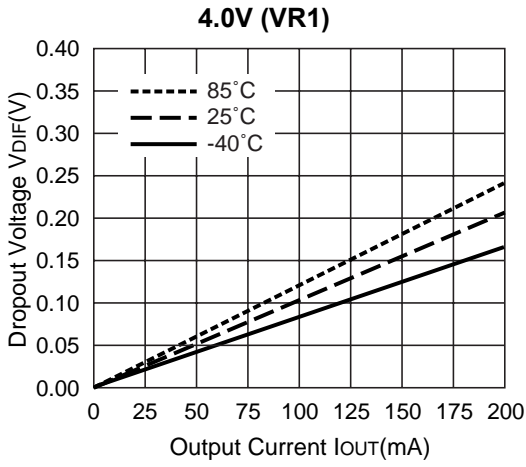


3) Dropout Voltage vs. Output Current

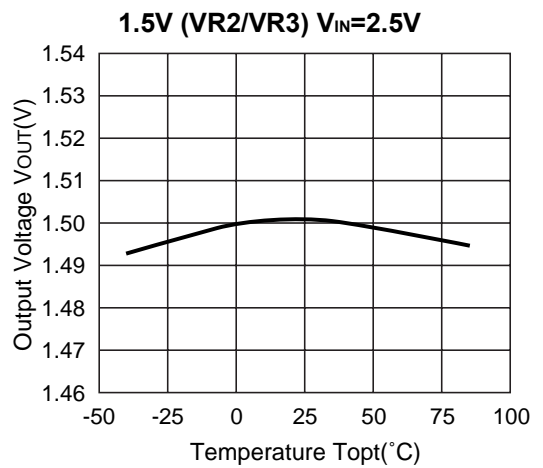
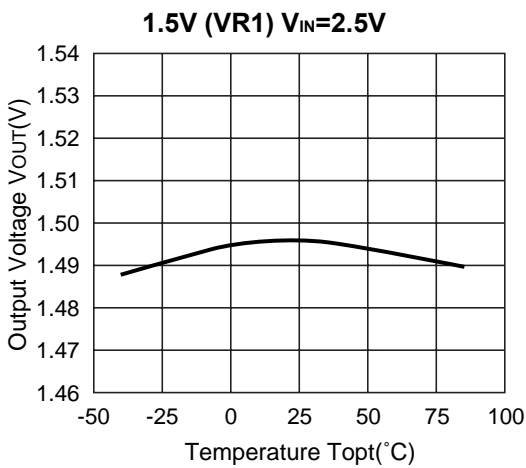


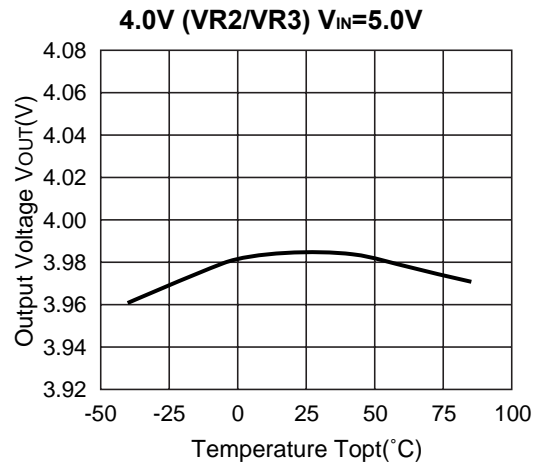
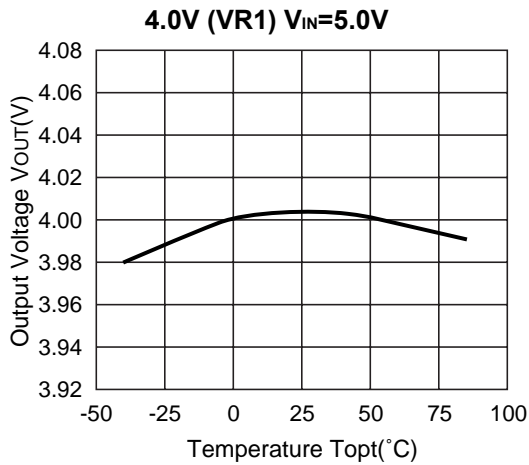
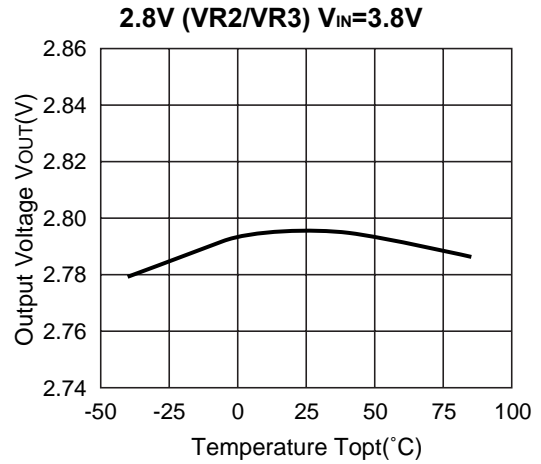
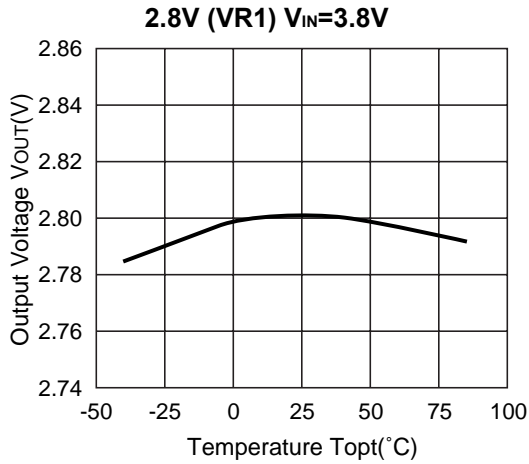




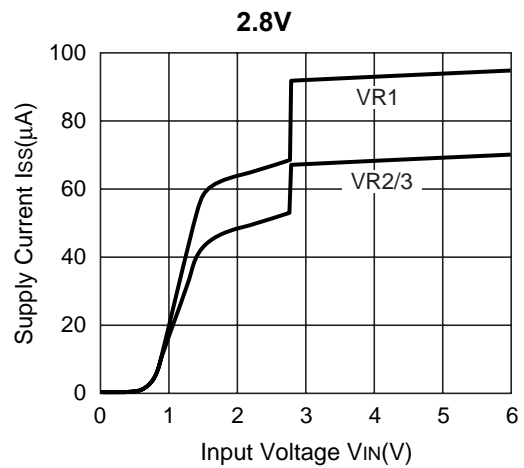
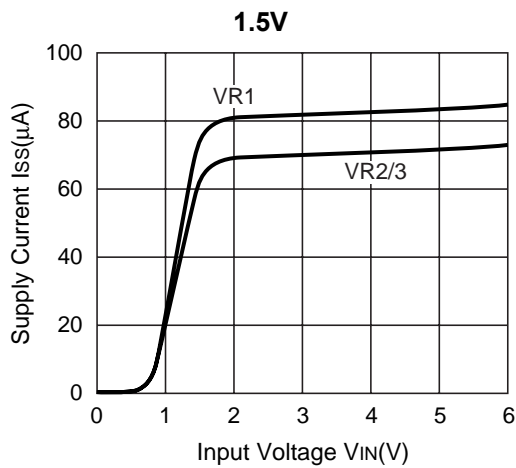


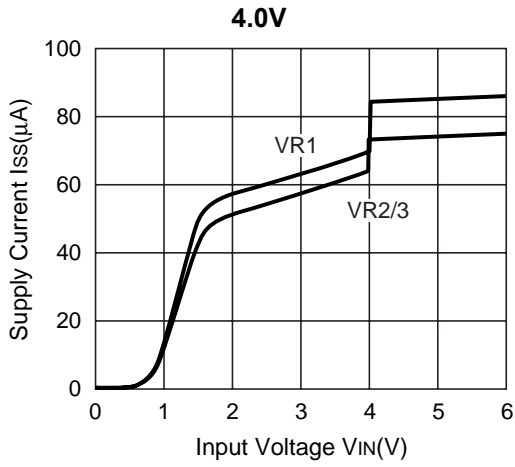
4) Output Voltage vs. Temperature ($I_{OUT}=30mA$)



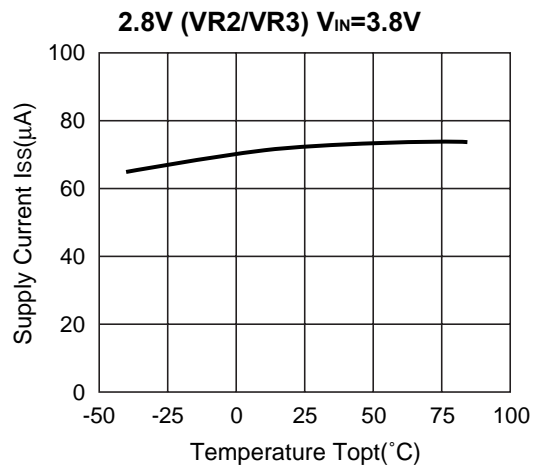
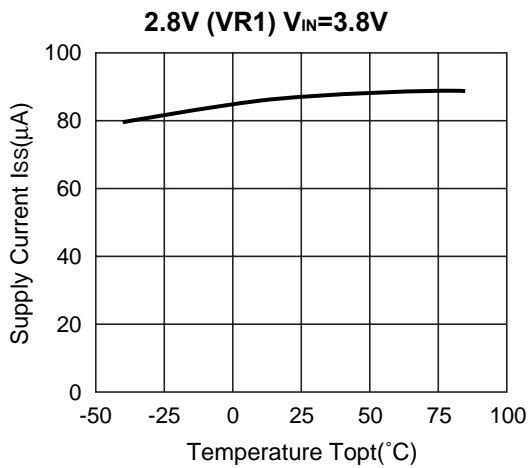
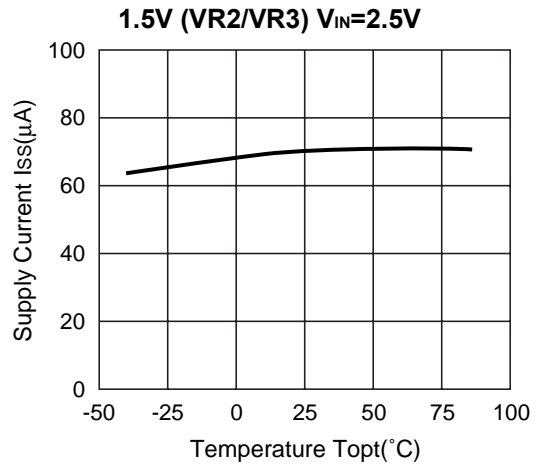
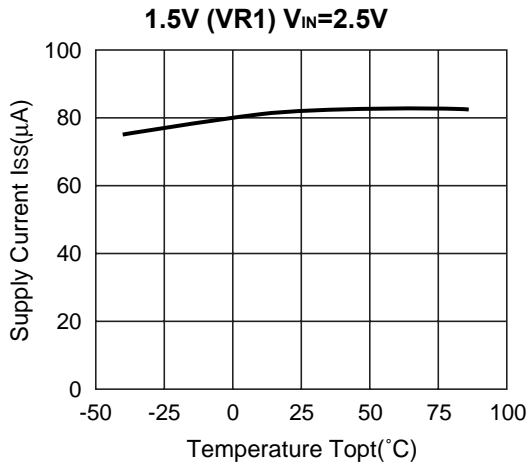


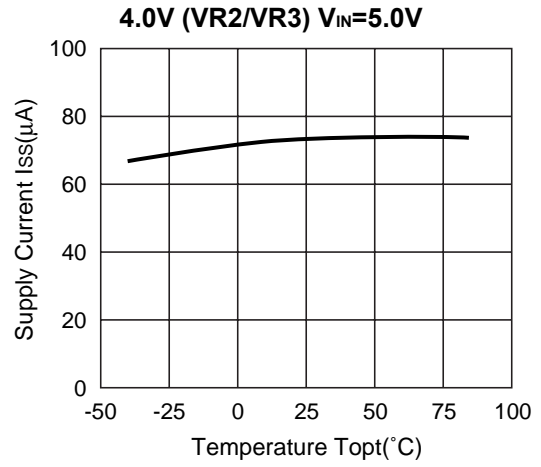
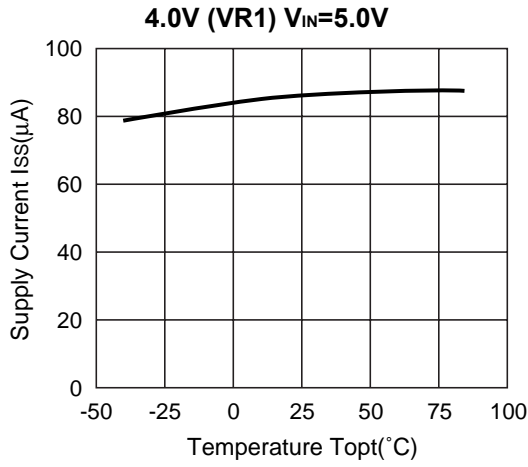
5) Supply Current vs. Input Voltage ($T_{opt}=25^{\circ}C$)



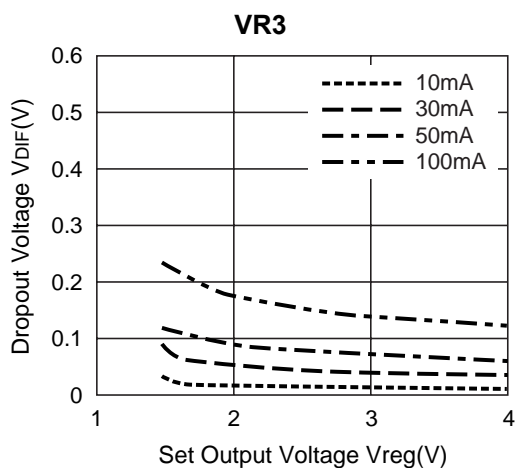
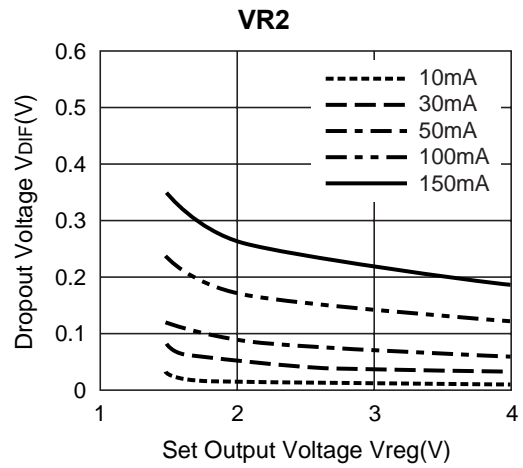
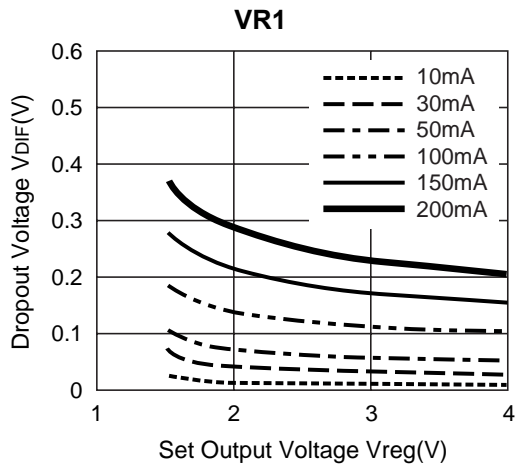


6) Supply Current vs. Temperature

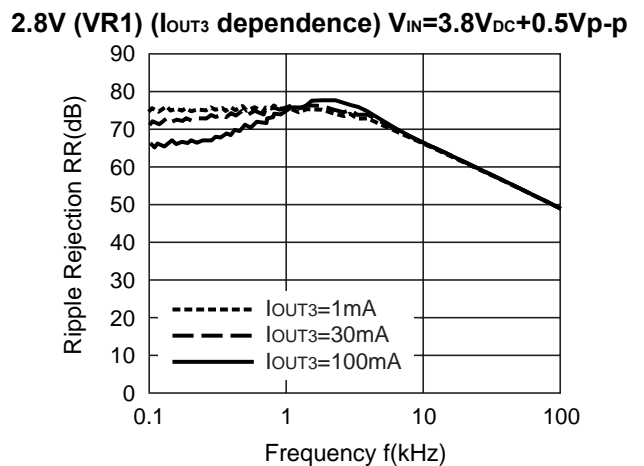
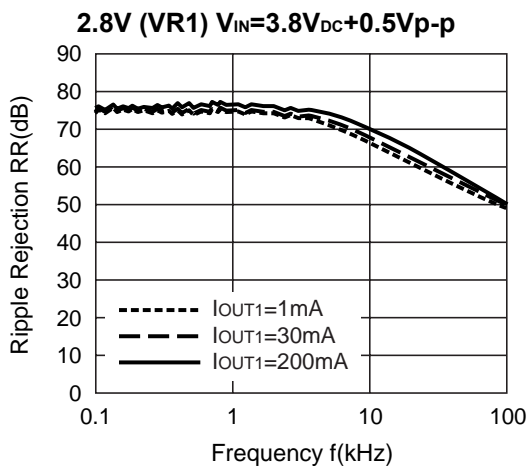
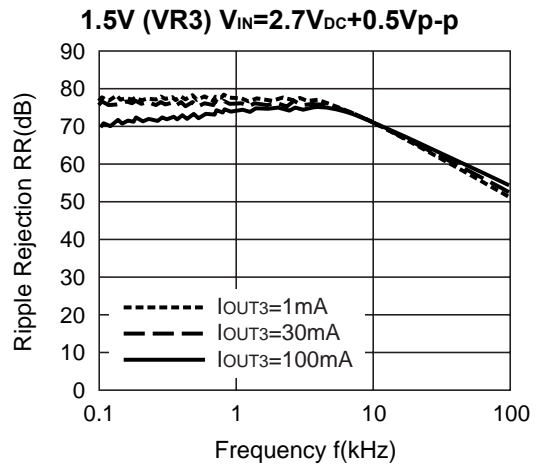
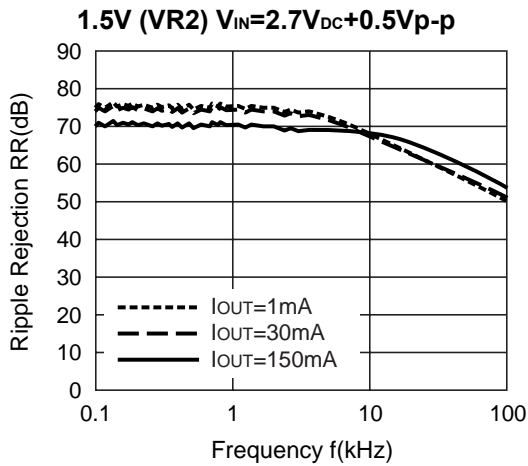
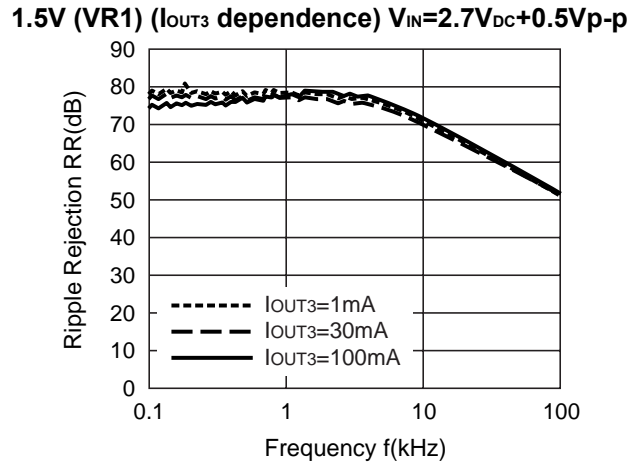
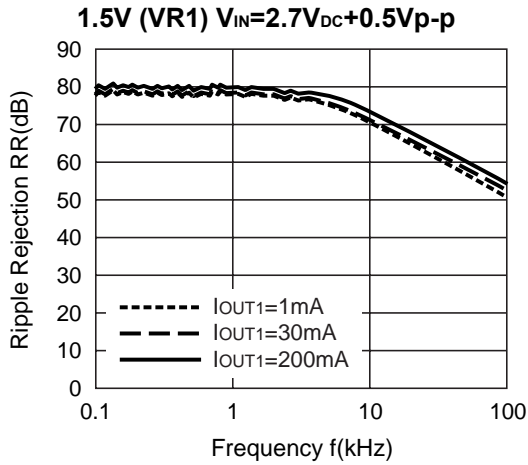


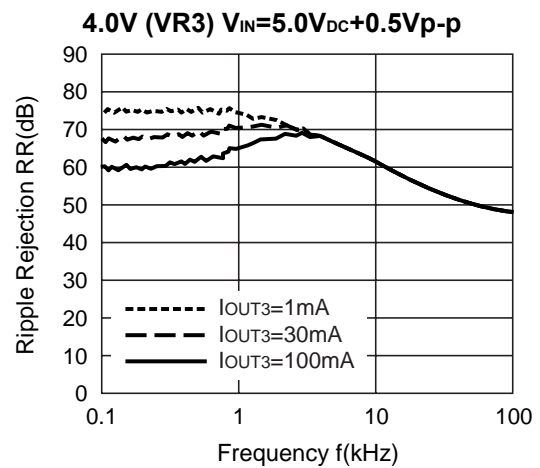
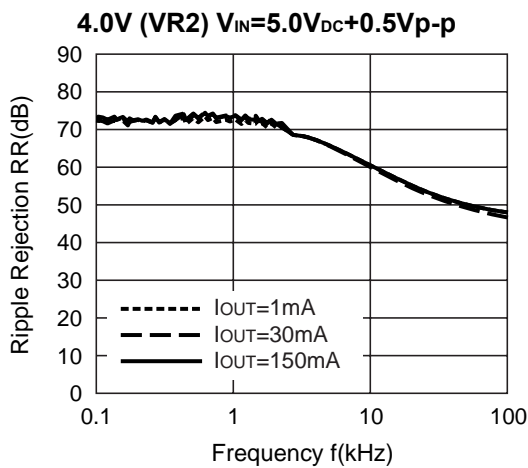
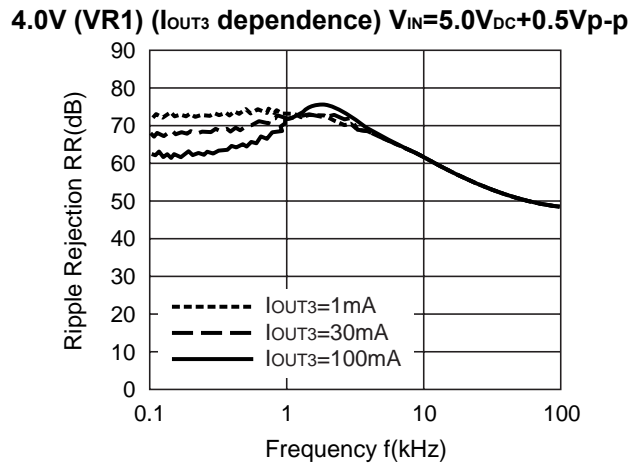
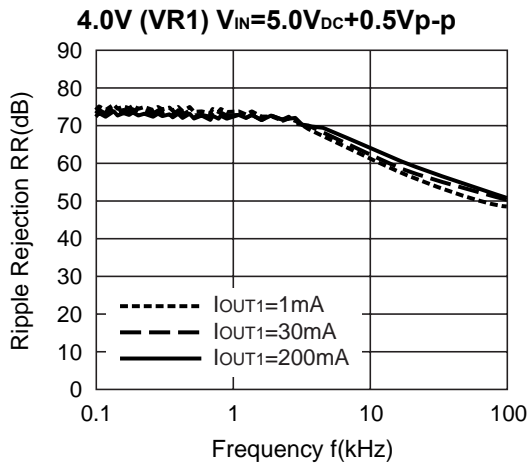
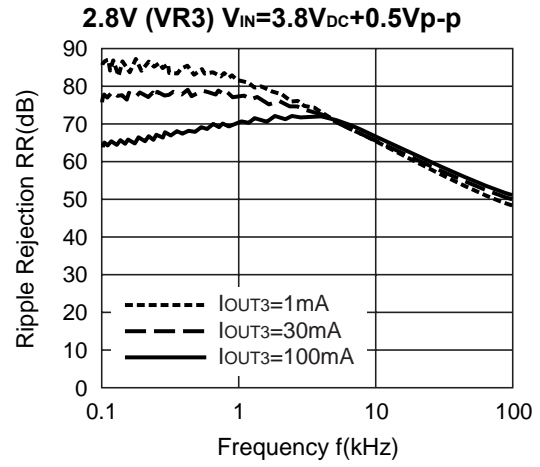
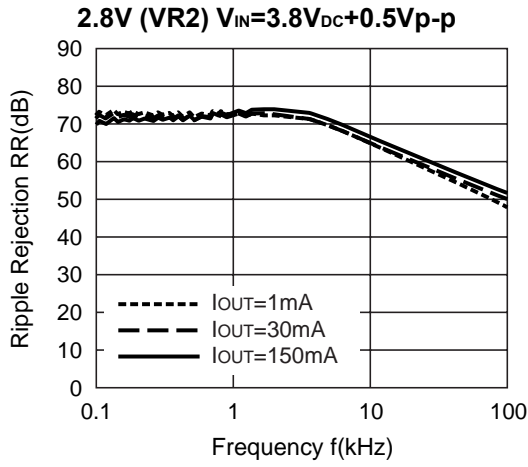


7) Dropout Voltage vs. Set Output Voltage (T_{opt}=25°C)

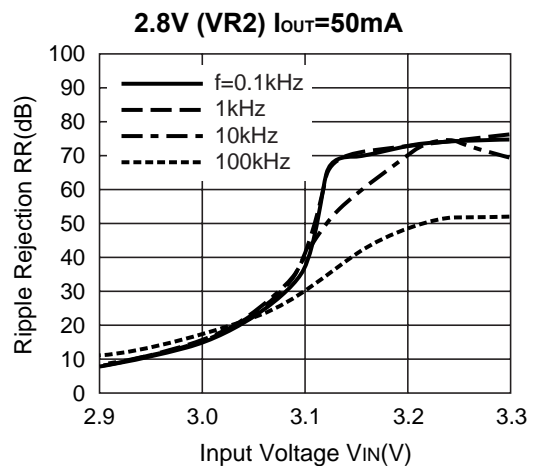
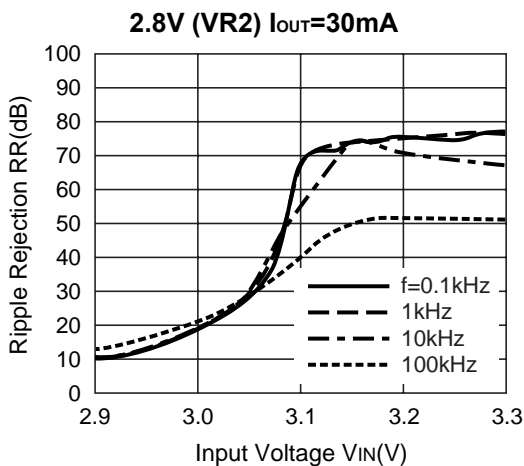
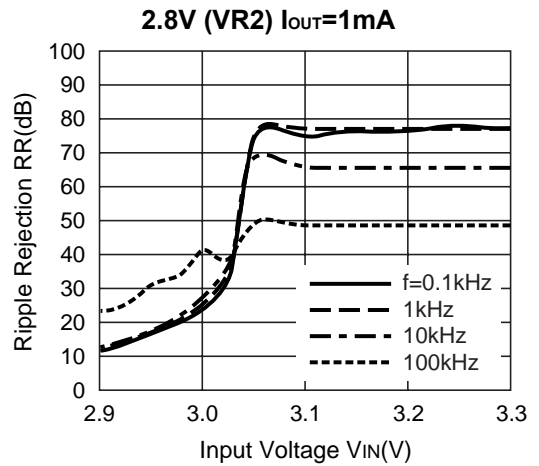
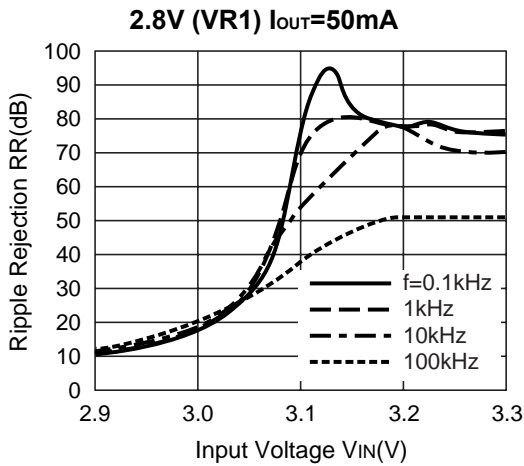
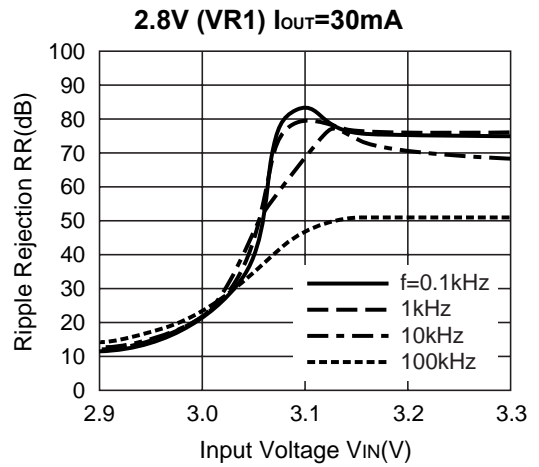
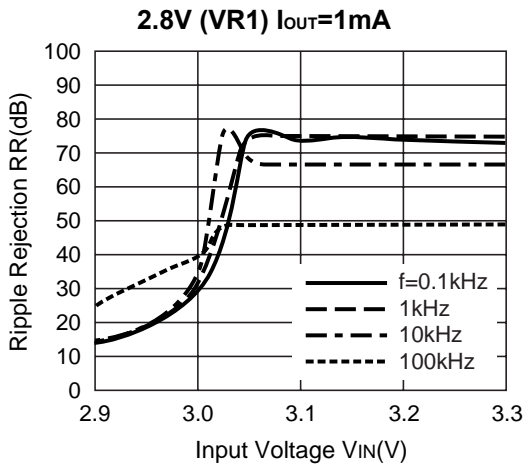


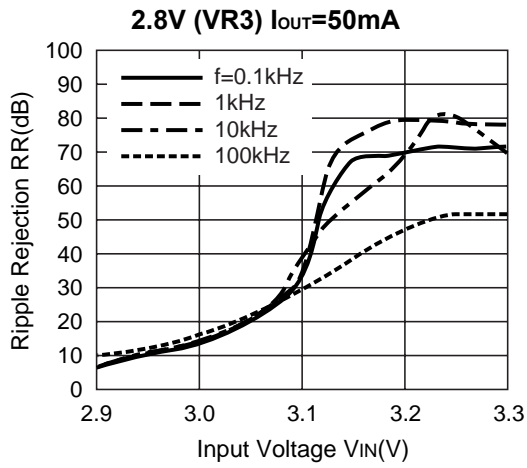
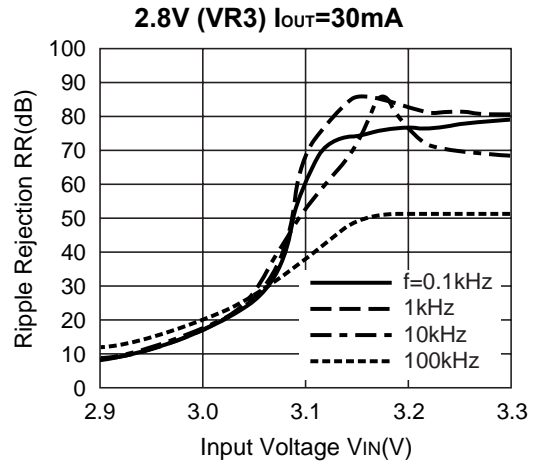
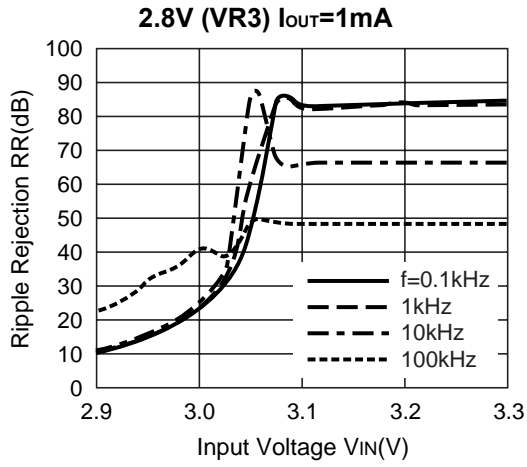
8) Ripple Rejection vs. Frequency (Topt=25°C, COUT=Ceramic 1.0μF)





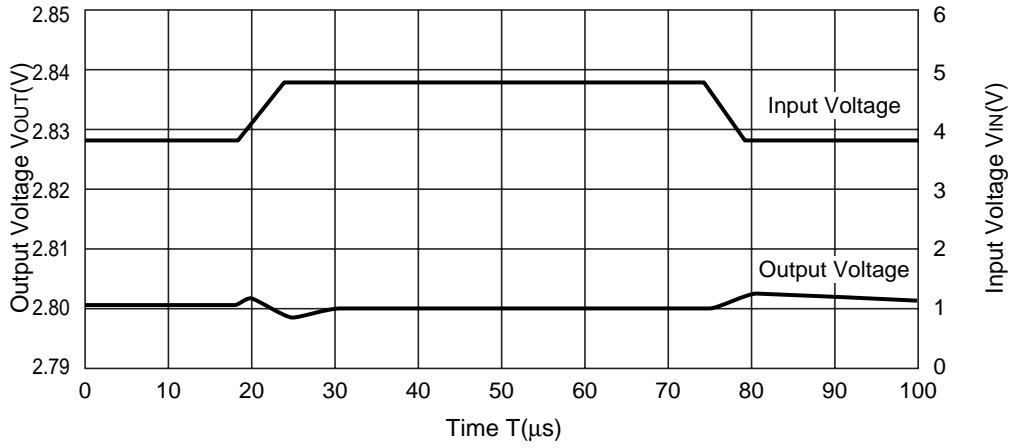
9) Ripple Rejection vs. DC Input Bias (Topt=25°C, COUT=1.0μF)



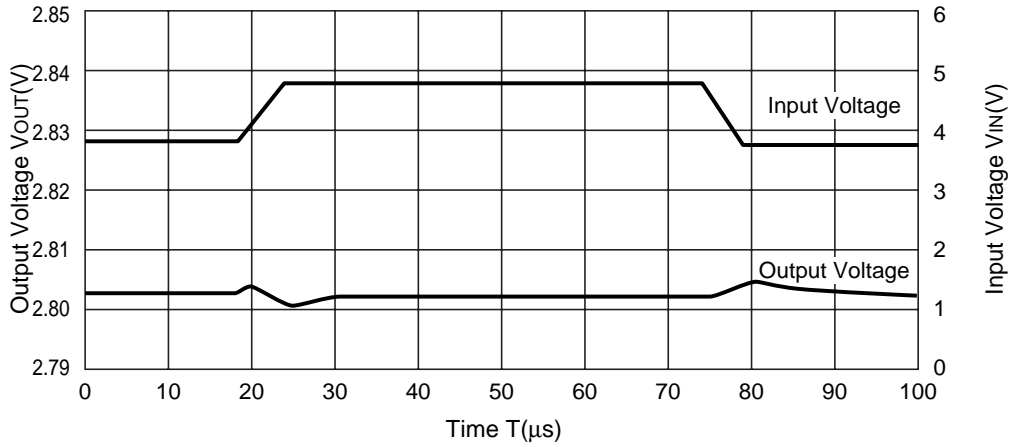


10) Line Transient Response ($I_{OUT}=30mA$, $C_{IN}=none$, $t_r=t_f=5\mu s$, $C_{OUT}=Ceramic\ 1\mu F$)

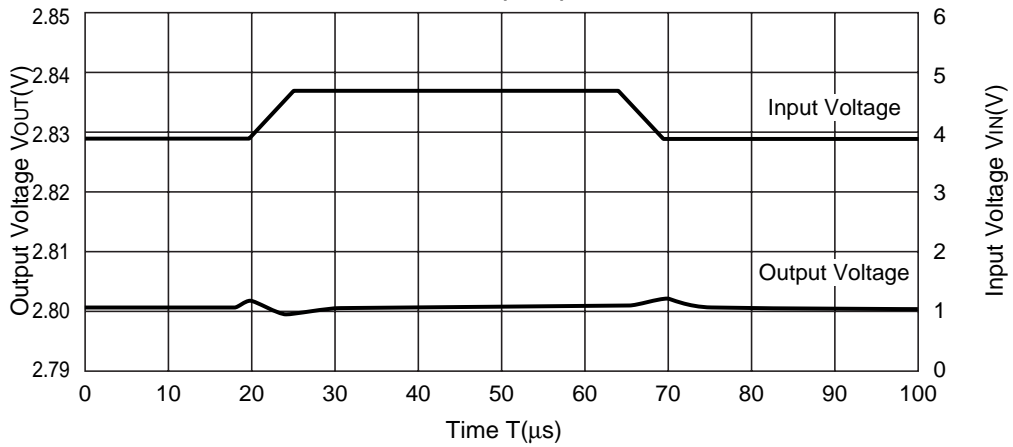
2.8V(VR1)



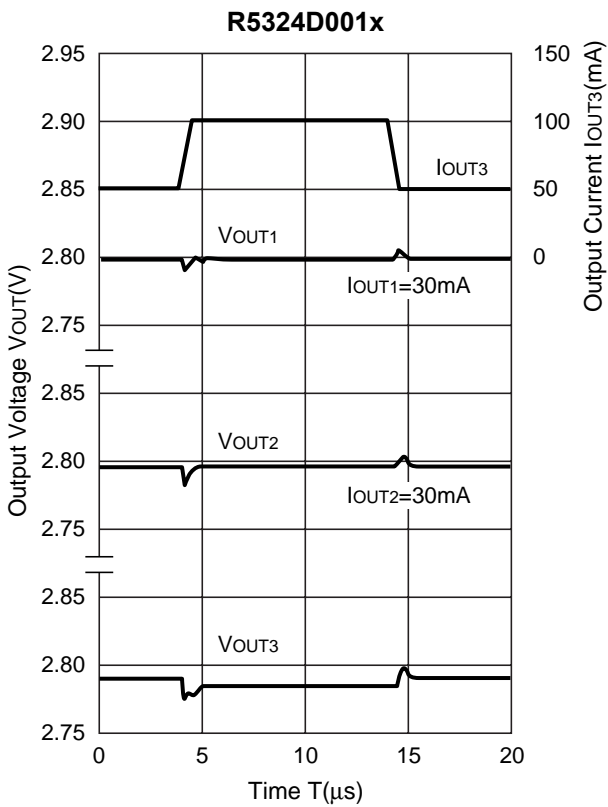
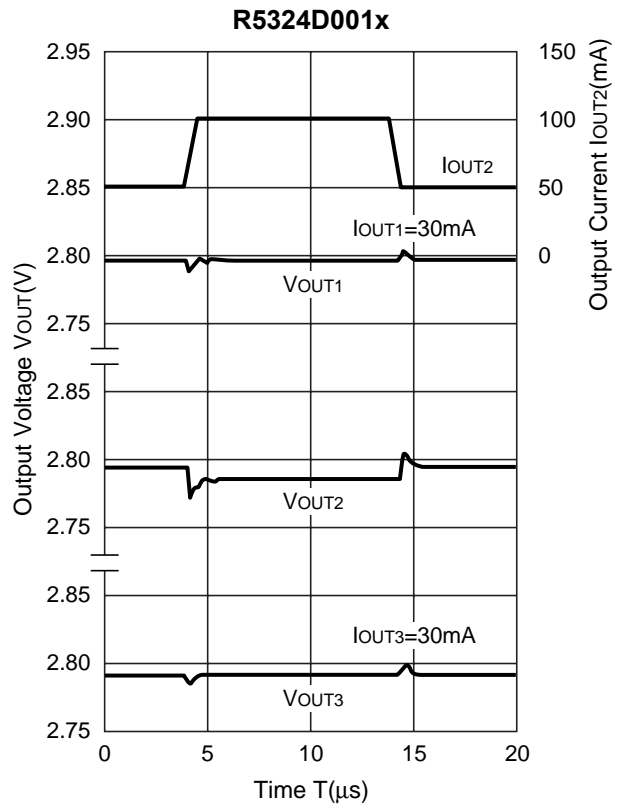
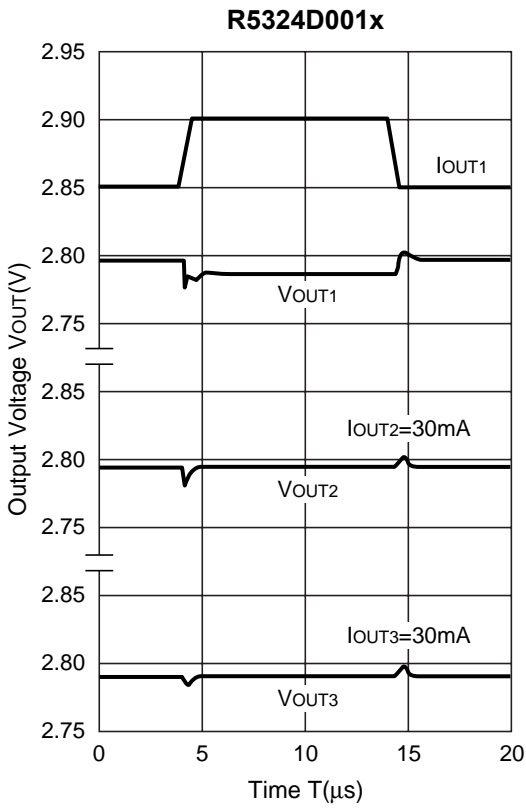
2.8V(VR2)



2.8V(VR3)



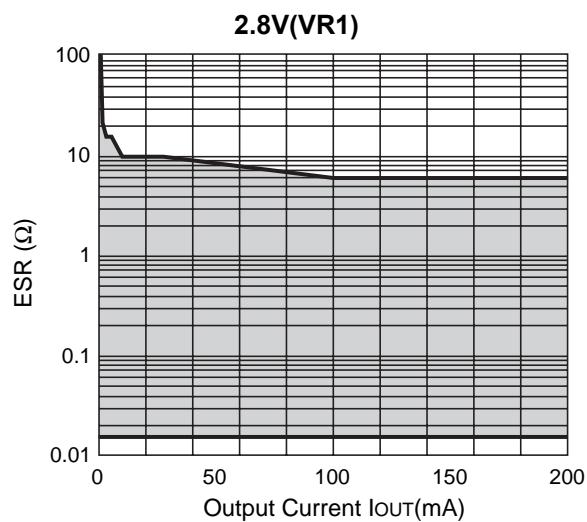
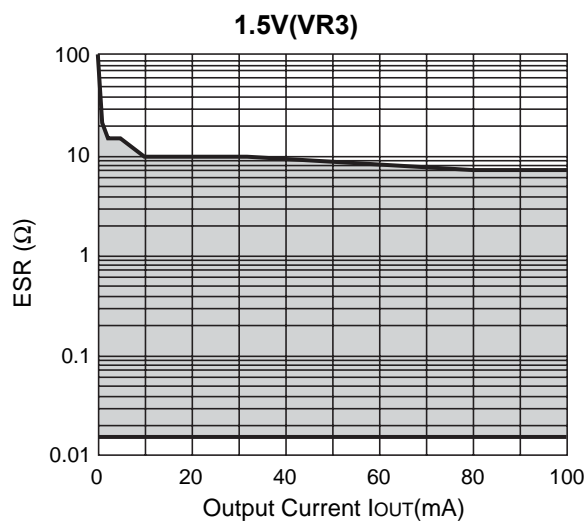
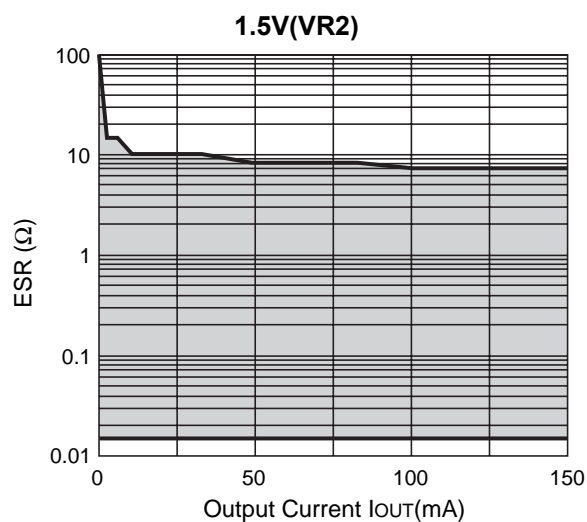
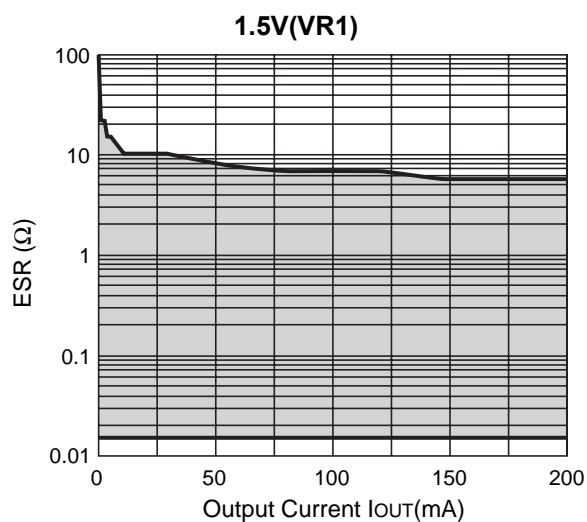
11) Load Transient Response (C_{IN} =Ceramic $1.0\mu F$, C_{OUT} =Ceramic $1.0\mu F$)

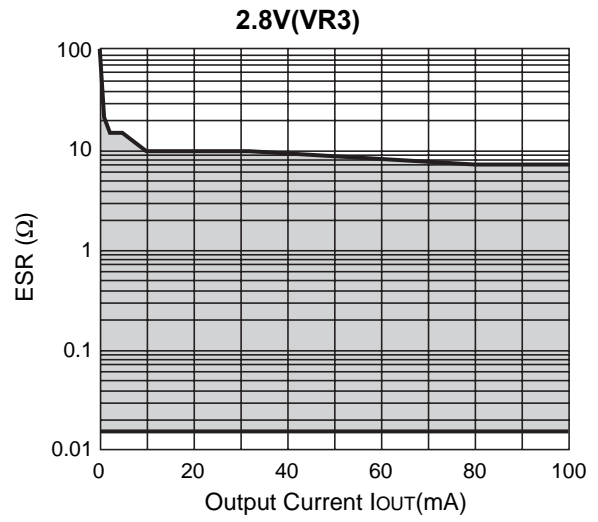
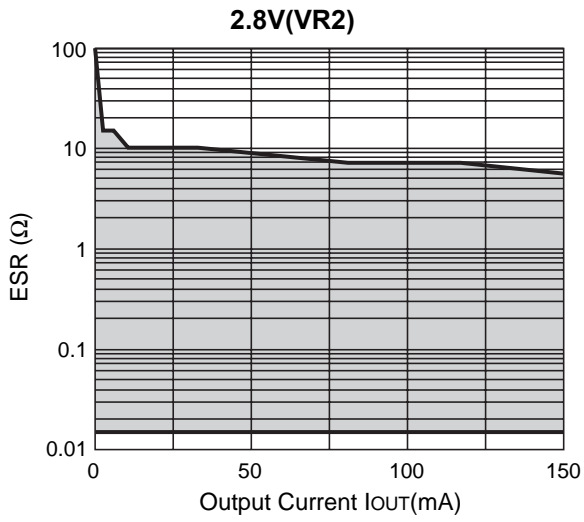


ESR vs. Output Current

To use this IC, ESR of the output capacitors should be set in the range of the following graphs.

Noise level is measured with a spectrum analyzer and hatched area shows stable areas of which noise level is approximately equal or less than $40\mu\text{V}$ (Avg.). The relation between Load Current (I_{OUT}) and Equivalent Series Resistors (ESR) value of external output capacitor with the stable area is shown below;





Measuring Conditions

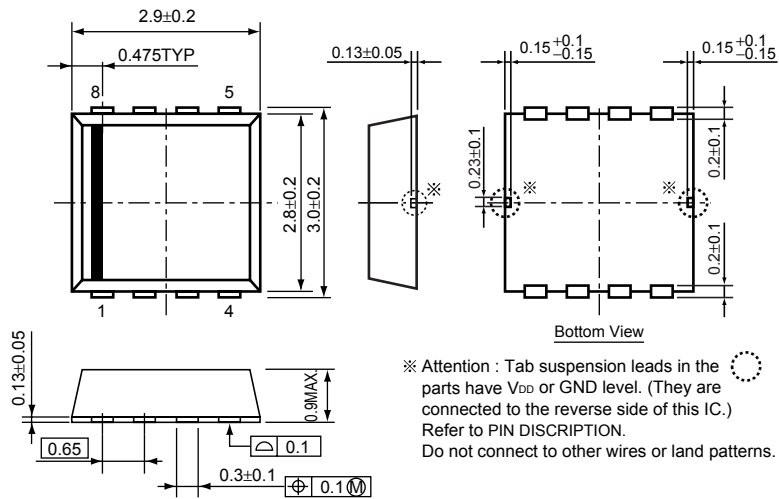
Frequency Band : 10Hz to 2MHz

Temperature : -40°C to 85°C

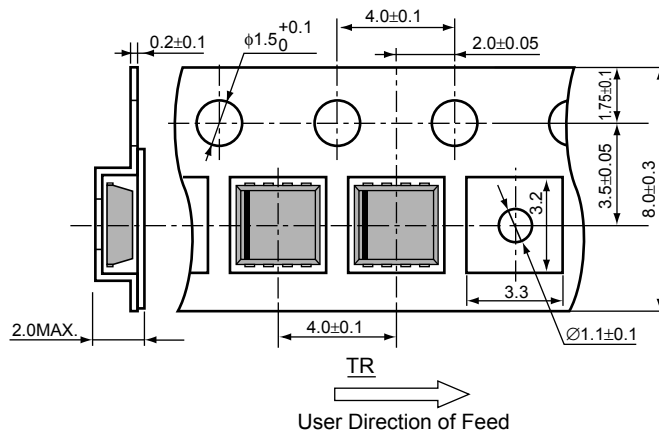
• SON-8

Unit: mm

PACKAGE DIMENSIONS

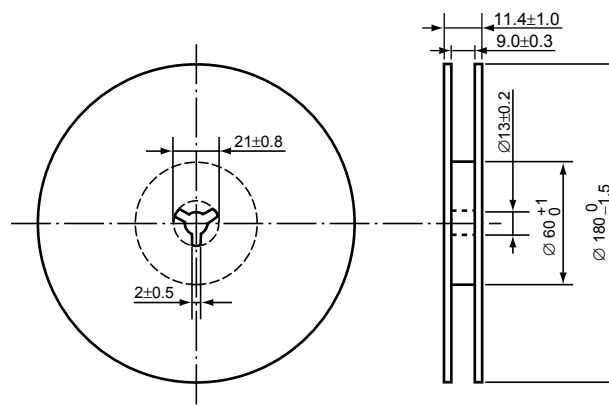


TAPING SPECIFICATION



TAPING REEL DIMENSIONS

(1reel=3000pcs)



POWER DISSIPATION (SON-8)

This specification is at mounted on board. Power Dissipation (P_D) depends on conditions of mounting on board. This specification is based on the measurement at the condition below:

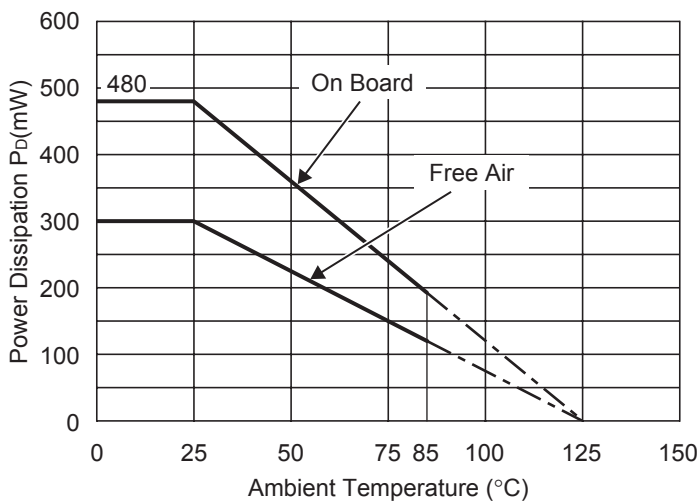
Measurement Conditions

	Standard Land Pattern
Environment	Mounting on Board (Wind velocity=0m/s)
Board Material	Glass cloth epoxy plactic (Double sided)
Board Dimensions	40mm × 40mm × 1.6mm
Copper Ratio	Top side : Approx. 50% , Back side : Approx. 50%
Through-hole	φ0.5mm × 44pcs

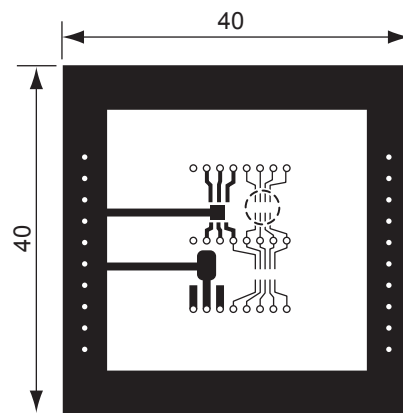
Measurement Result

($T_{opt}=25^{\circ}C, T_{jmax}=125^{\circ}C$)

	Standard Land Pattern	Free Air
Power Dissipation	480mW	300mW
Thermal Resistance	$\theta_{ja}=(125-25^{\circ}C)/0.48W=208^{\circ}C/W$	333 $^{\circ}C/W$



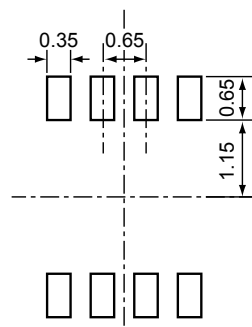
Power Dissipation



Measurement Board Pattern

○ IC Mount Area (Unit : mm)

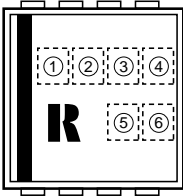
RECOMMENDED LAND PATTERN



(Unit: mm)

R5324D SERIES MARK SPECIFICATION

• SON-8



① to ④ : Product Code (refer to Part Number vs. Product Code)

⑤, ⑥ : Lot Number

• Part Number vs. Product Code

Part Number	Product Code			
	①	②	③	④
R5324D001A	E	0	1	A
R5324D001B	E	0	1	B
R5324D002A	E	0	2	A
R5324D002B	E	0	2	B
R5324D003A	E	0	3	A
R5324D003B	E	0	3	B
R5324D004A	E	0	4	A
R5324D004B	E	0	4	B